SN54ALS374A, SN54AS374, SN74ALS374A, SN74AS374
OCTAL D-TYPE EDGE-TRIGGERED FLIP-FLOPS
WITH 3-STATE OUTPUTS

SDAS167C – APRIL 1982 – REVISED NOVEMBER 1999

- **D-Type Flip-Flops in a Single Package With 3-State Bus Driving True Outputs**
- **Full Parallel Access for Loading**
- **Buffered Control Inputs**
- **Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs**

SN54ALS374A, SN54AS374 . . . J PACKAGE
SN74ALS374A, SN74AS374 . . . DW OR N PACKAGE
(TOP VIEW)

$\overline{OE}$	1	20	V_{CC}
1Q	2	19	8Q
1D	3	18	8D
2D	4	17	7D
2Q	5	16	7Q
3Q	6	15	6Q
3D	7	14	6D
4D	8	13	5D
4Q	9	12	5Q
GND	10	11	CLK

SN54ALS374A, SN54AS374 . . . FK PACKAGE
(TOP VIEW)

Pins (top, left to right): 1D, 1Q, $\overline{OE}$, V_{CC}, 8Q
Numbers top row: 3, 2, 1, 20, 19

Left		Right	
2D	4	18	8D
2Q	5	17	7D
3Q	6	16	7Q
3D	7	15	6Q
4D	8	14	6D

Numbers bottom row: 9, 10, 11, 12, 13
Pins (bottom): 4Q, GND, CLK, 5Q, 5D

description

These octal D-type edge-triggered flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.
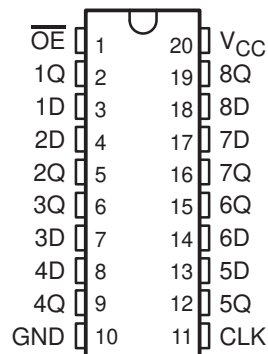
On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels set up at the data (D) inputs.

A buffered output-enable ($\overline{OE}$) input places the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without interface or pullup components.
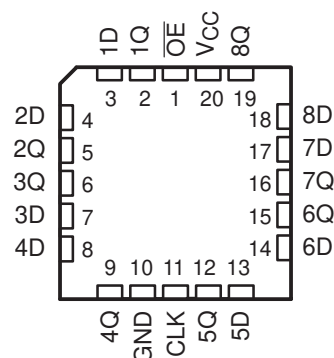
$\overline{OE}$ does not affect internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54ALS374A and SN54AS374 are characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS374A and SN74AS374 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE
(each flip-flop)

INPUTS			OUTPUT
$\overline{OE}$	CLK	D	Q
L	↑	H	H
L	↑	L	L
L	H or L	X	Q_0
H	X	X	Z

TEXAS INSTRUMENTS

SN54ALS374A, SN54AS374, SN74ALS374A, SN74AS374
OCTAL D-TYPE EDGE-TRIGGERED FLIP-FLOPS
WITH 3-STATE OUTPUTS

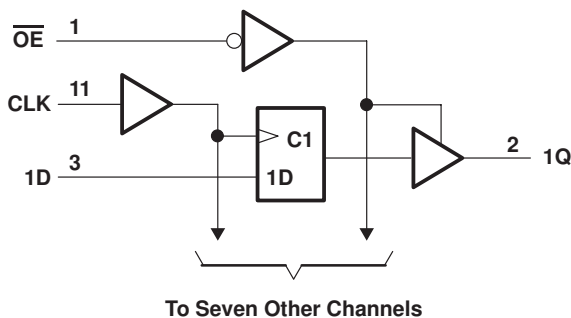SDAS167C – APRIL 1982 – REVISED NOVEMBER 1999

logic symbol†

$\overline{OE}$ 1

CLK   11

1D	3	2	1Q
2D	4	5	2Q
3D	7	6	3Q
4D	8	9	4Q
5D	13	12	5Q
6D	14	15	6Q
7D	17	16	7Q
8D	18	19	8Q

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and
IEC Publication 617-12.

logic diagram (positive logic)

To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V_{CC} .... –0.5 V to 7 V
Input voltage range, V_I .... –0.5 V to 7 V
Voltage applied to a disabled 3-state output .... –0.5 V to 5.5 V
Package thermal impedance, θ_{JA} (see Note 1): DW package .... 58°C/W
                             N package .... 69°C/W
Storage temperature range, T_{stg} .... –65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and
functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not
implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions

		SN54ALS374A			SN74ALS374A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			–1			–2.6	mA
I_{OL}	Low-level output current			12			24	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS374A			SN74ALS374A			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = −0.4 mA	V_{CC}−2			V_{CC}−2			V
	V_{CC} = 4.5 V	I_{OH} = −1 mA	2.4	3.3					
		I_{OH} = −2.6 mA				2.4	3.2		
V_{OL}	V_{CC} = 4.5 V	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 24 mA					0.35	0.5	
I_{OZH}	V_{CC} = 5.5 V,	V_O = 2.7 V			20			20	µA
I_{OZL}	V_{CC} = 5.5 V,	V_O = 0.4 V			−20			−20	µA
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	µA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			−0.2			−0.2	mA
I_O‡	V_{CC} = 5.5 V,	V_O = 2.25 V	−20		−112	−30		−112	mA
I_{CC}	V_{CC} = 5.5 V	Outputs high		11	20		11	19	mA
		Outputs low		19	28		19	28	
		Outputs disabled		20	31		20	31	

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			SN54ALS374A		SN74ALS374A		UNIT
			MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency			30		35	MHz
t_w	Pulse duration	CLK high or low	16.5		14		ns
t_{su}	Setup time	Data before CLK↑	10		10		ns
t_h	Hold time	Data after CLK↑	4		0		ns

switching characteristics over recommended operating conditions (unless otherwise noted (see Figure 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ALS374A		SN74ALS374A		UNIT
			MIN	MAX	MIN	MAX	
f_{max}			30		35		MHz
t_{PLH}	CLK	Q	3	14	3	12	ns
t_{PHL}			5	17	5	16	
t_{PZH}	$\overline{OE}$	Q	3	18	3	17	ns
t_{PZL}			5	21	5	18	
t_{PHZ}	$\overline{OE}$	Q	1	11	1	10	ns
t_{PLZ}			2	19	2	18	

recommended operating conditions

		SN54AS374			SN74AS374			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			−12			−15	mA
I_{OL}	Low-level output current			32			48	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54AS374			SN74AS374			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}		V_{CC} = 4.5 V,	I_I = −18 mA			−1.2			−1.2	V
V_{OH}		V_{CC} = 4.5 V to 5.5 V,	I_{OH} = −2 mA	V_{CC}−2			V_{CC}−2			V
		V_{CC} = 4.5 V	I_{OH} = −12 mA	2.4	3.2					
			I_{OH} = −15 mA				2.4	3.3		
V_{OL}		V_{CC} = 4.5 V	I_{OL} = 32 mA		0.29	0.5				V
			I_{OL} = 48 mA					0.34	0.5	
I_{OZH}		V_{CC} = 5.5 V,	V_O = 2.7 V			50			50	μA
I_{OZL}		V_{CC} = 5.5 V,	V_O = 0.4 V			−50			−50	μA
I_I		V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}		V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	μA
I_{IL}	$\overline{OE}$, CLK	V_{CC} = 5.5 V,	V_I = 0.4 V			−0.5			−0.5	mA
	Data					−3			−2	
I_O‡		V_{CC} = 5.5 V,	V_O = 2.25 V	−30		−112	−30		−112	mA
I_{CC}		V_{CC} = 5.5 V	Outputs high		77	120		77	120	mA
			Outputs low		84	128		84	128	
			Outputs disabled		84	128		84	128	

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			SN54AS374		SN74AS374		UNIT
			MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency			100*		125	MHz
t_w	Pulse duration	CLK high	5.5*		4		ns
		CLK low	3*		3		
t_{su}	Setup time	Data before CLK↑	3*		2		ns
t_h	Hold time	Data after CLK↑	3*		2		ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating conditions (unless otherwise noted) (see Figure 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54AS374		SN74AS374		UNIT
			MIN	MAX	MIN	MAX	
f_{max}			100*		125		MHz
t_{PLH}	CLK	Q	3	11	3	8	ns
t_{PHL}			4	11.5	4	9	
t_{PZH}	$\overline{OE}$	Q	2	7	2	6	ns
t_{PZL}			3	11	3	10	
t_{PHZ}	$\overline{OE}$	Q	2	10	2	6	ns
t_{PLZ}			2	7	2	6	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

TEXAS
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APPLICATION INFORMATION
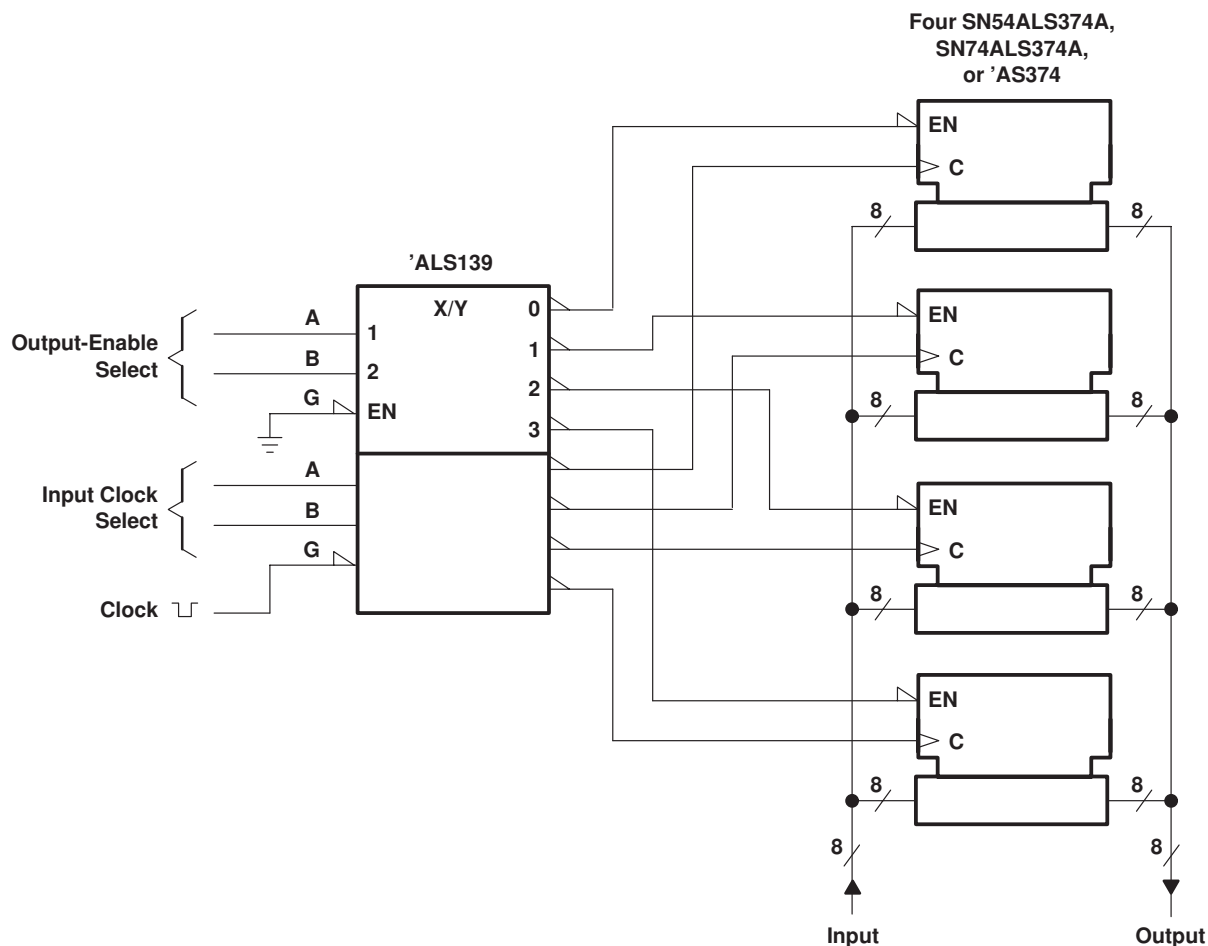
Figure 1. Expandable 4-Word by 8-Bit General File Register

APPLICATION INFORMATION
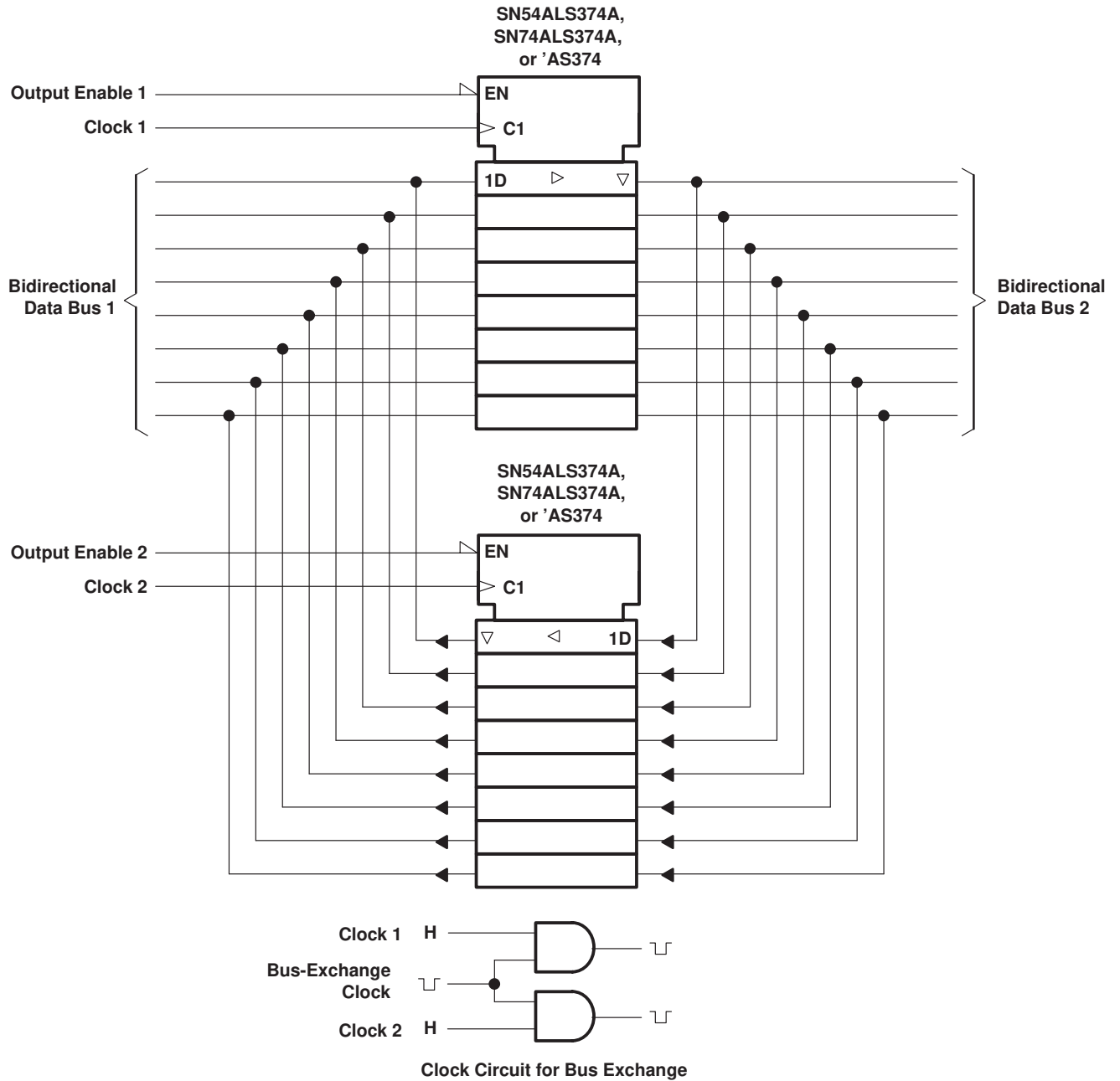
Figure 2. Bidirectional Bus Driver

PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES

**LOAD CIRCUIT FOR
BI-STATE TOTEM-POLE OUTPUTS**

**LOAD CIRCUIT FOR
OPEN-COLLECTOR OUTPUTS**

**LOAD CIRCUIT FOR
3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**

**VOLTAGE WAVEFORMS
PULSE DURATIONS**

**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES**
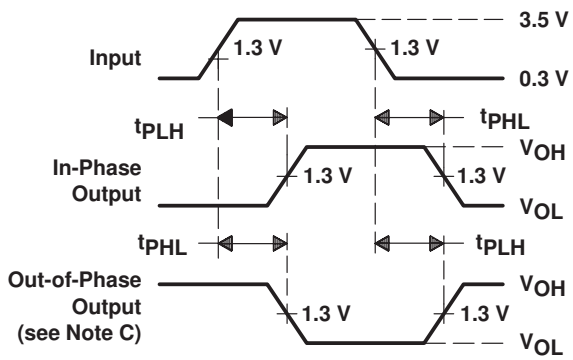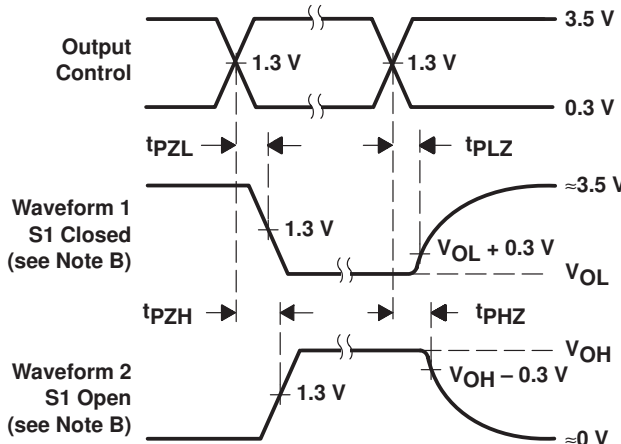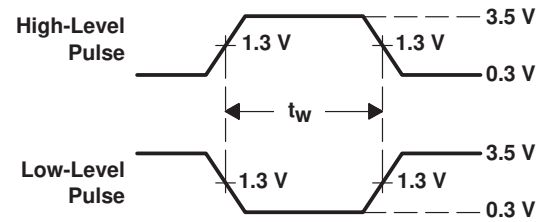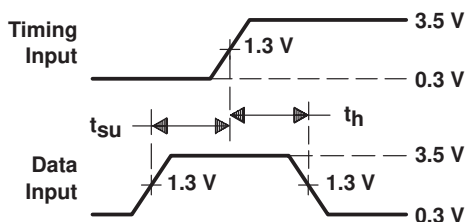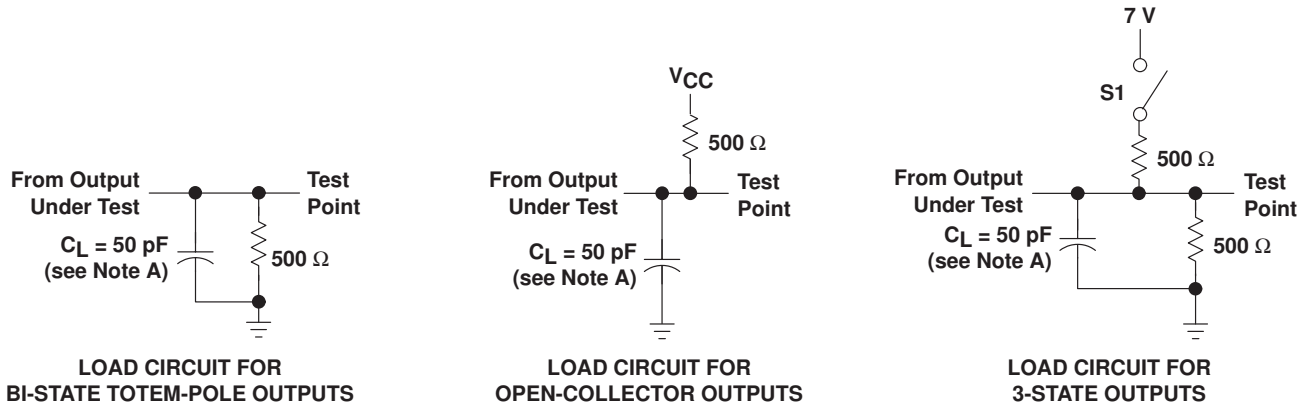
NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
D. All input pulses have the following characteristics: PRR ≤ 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
E. The outputs are measured one at a time with one transition per measurement.

Figure 3. Load Circuits and Voltage Waveforms

**TEXAS
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POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
5962-9756201Q2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-9756201QRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-9756201QSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
83020022A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
8302002RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
8302002SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
JM38510/37204B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/37204BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN54ALS374AJ	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN54AS374J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN74ALS374ADBLE	OBSOLETE	SSOP	DB	20		None	Call TI	Call TI
SN74ALS374ADBR	ACTIVE	SSOP	DB	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS374ADW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS374ADWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS374AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS374AN3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SN74ALS374ANSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS374DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74AS374DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74AS374N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AS374N3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SN74AS374NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54ALS374AFK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS374AJ	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS374AW	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS374FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS374J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS374W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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